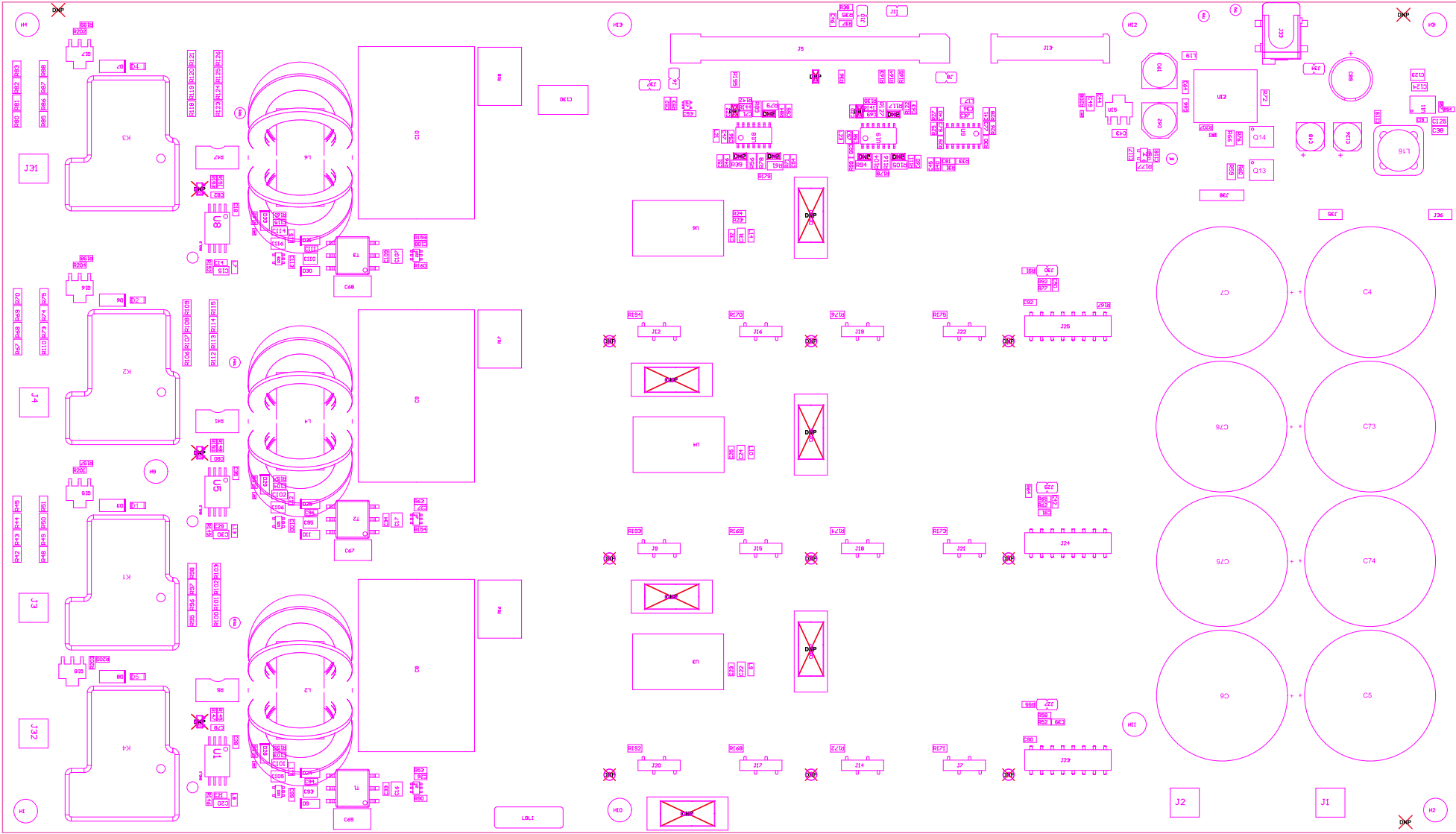


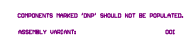
Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
Z22 ■ These assemblies are ESD sensitive. ESD precautions shall be observed.
Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED "DNP" SHOULD NOT BE POPULATED.
ASSEMBLY INSTRUCTIONS

001

PCB VIEWED FROM TOP SIDE	BOARD #	TDN-02008Power Card	REV	E4	SUN REV	Not In VersionControl
LAYER NAME = ITS Assembly Top	TD #	TDN-02008				
PLOT NAME = Top Assembly Drawing	GENERATED	1	2/15/2019	By:4020 WH	TECHNICAL INSTRUMENTS	



PLOT VIEWED FROM BOTTOM SIDE		BOARD #	TID#-010039_Power Card	REV	E4	REV REV	Not In VersionControl
LAYER NAME = PG Assembly Bottom		TID #	TID#-010039				
PLOT NAME =	Bottom Assembly Drawing	GENERATED	1	2/15/2025	9x45.36 A1	TECHNICAL INSTRUMENTS	